



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

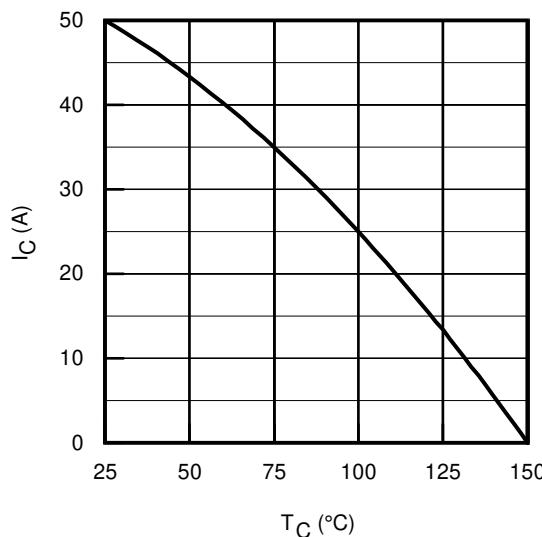
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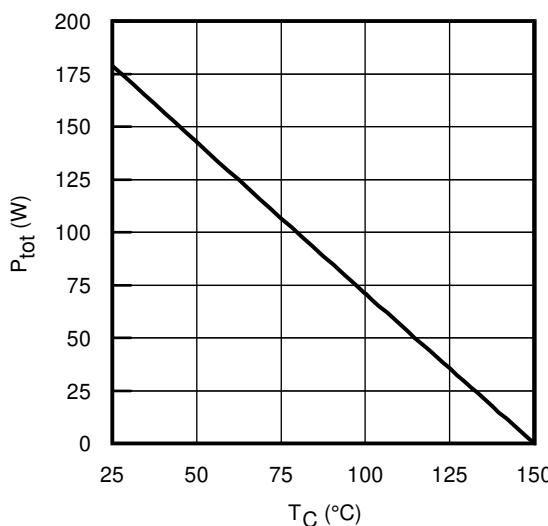
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



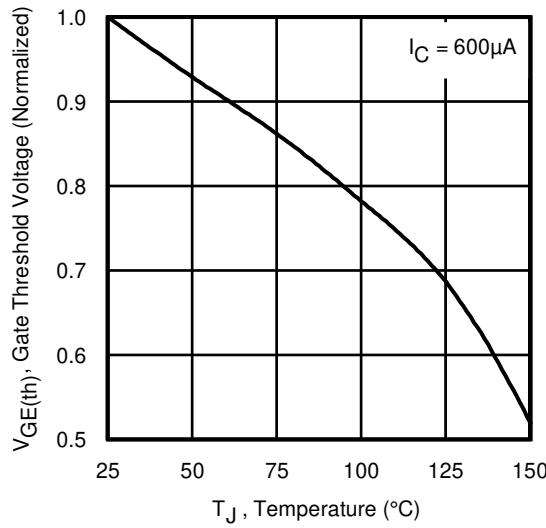




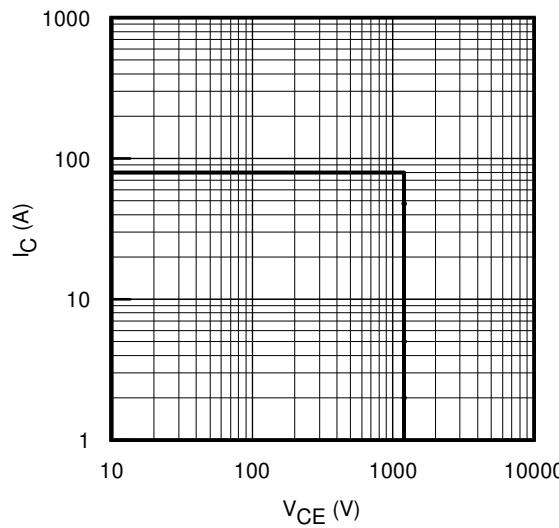
**Fig. 1 - Maximum DC Collector Current vs. Case Temperature**



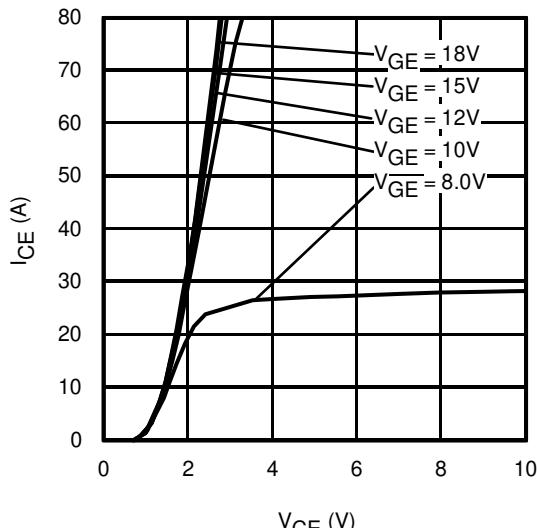
**Fig. 2 - Power Dissipation vs. Case Temperature**



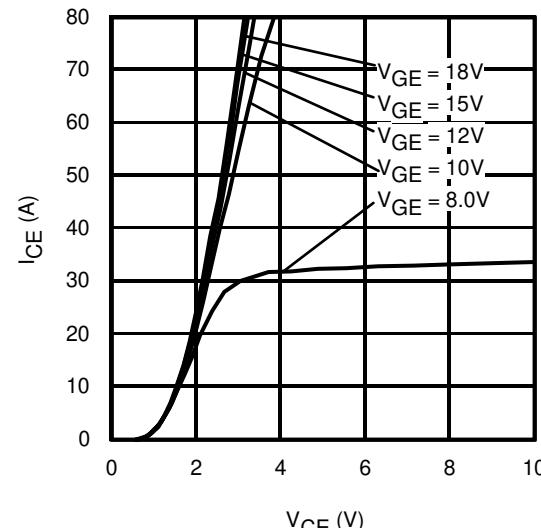
**Fig. 3 - Typical Gate Threshold Voltage (Normalized) vs. Junction Temperature**



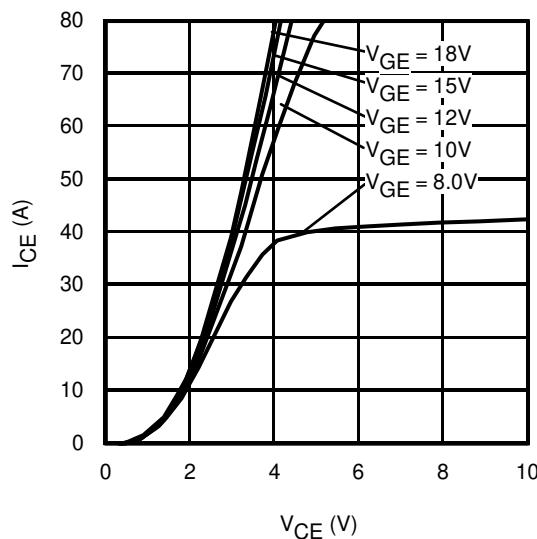
**Fig. 4 - Reverse Bias SOA**  
 $T_J = 150^\circ C; V_{GE} = 20V$



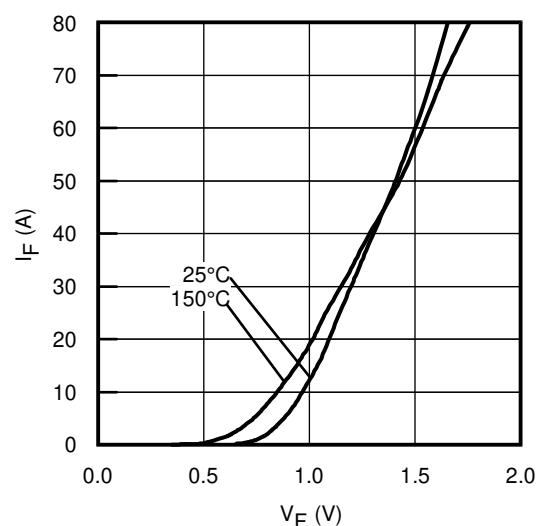
**Fig. 5 - Typ. IGBT Output Characteristics**  
 $T_J = -40^\circ C; t_p = 30\mu s$



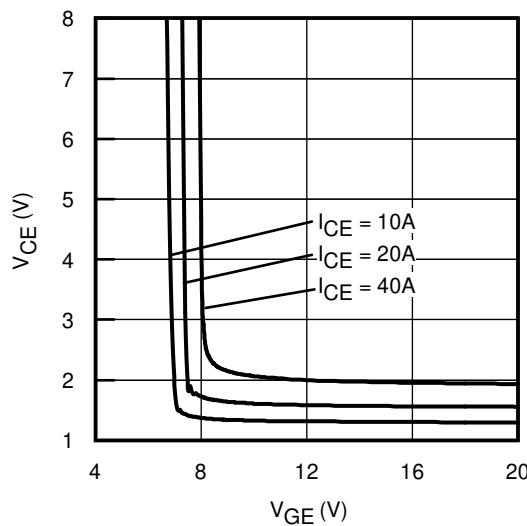
**Fig. 6 - Typ. IGBT Output Characteristics**  
 $T_J = 25^\circ C; t_p = 30\mu s$



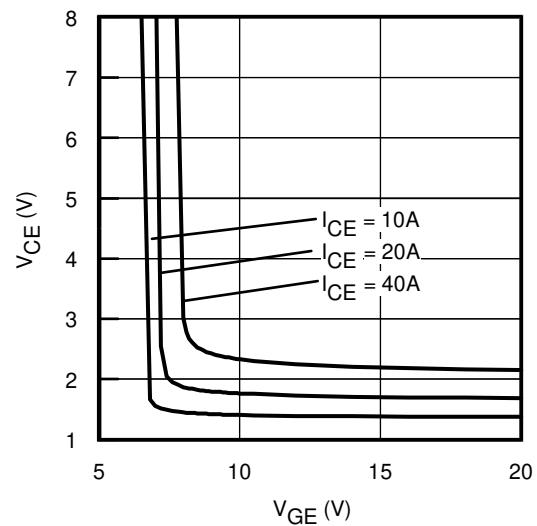
**Fig. 7** - Typ. IGBT Output Characteristics  
 $T_J = 150^\circ\text{C}$ ;  $t_p = 30\mu\text{s}$



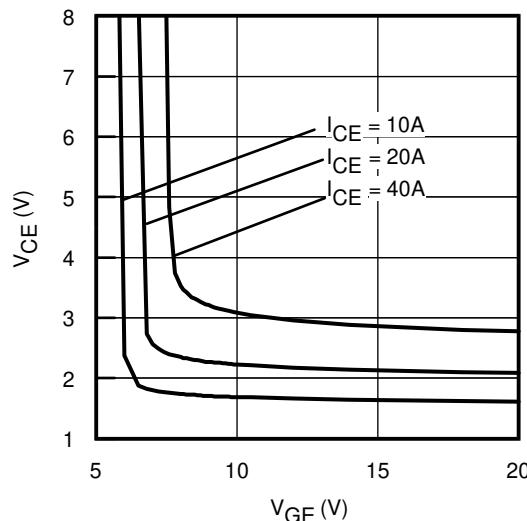
**Fig. 8** - Typ. Diode Forward Voltage Drop Characteristics



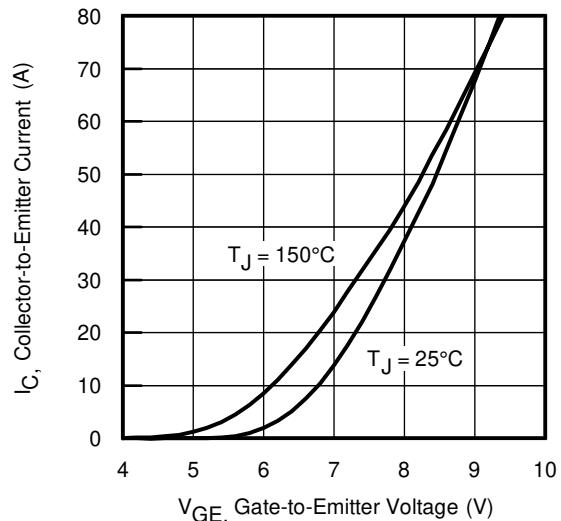
**Fig. 9** - Typical  $V_{CE}$  vs.  $V_{GE}$   
 $T_J = -40^\circ\text{C}$



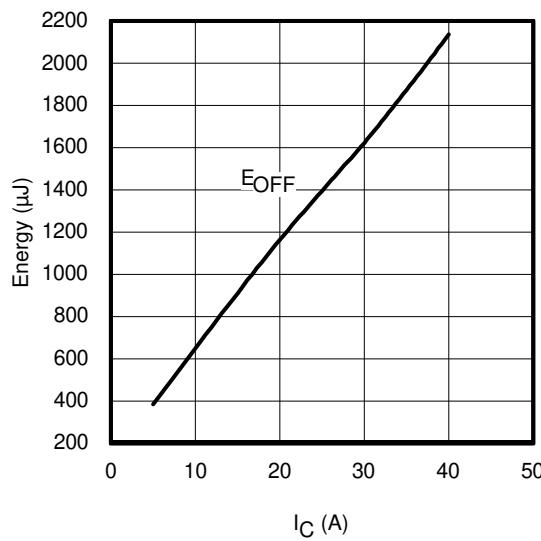
**Fig. 10** - Typical  $V_{CE}$  vs.  $V_{GE}$   
 $T_J = 25^\circ\text{C}$



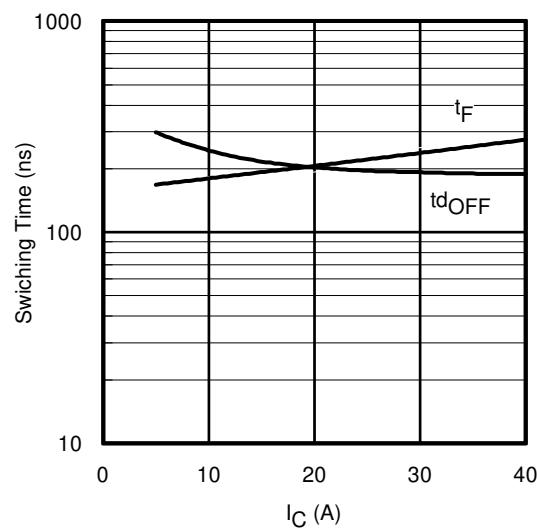
**Fig. 11** - Typical  $V_{CE}$  vs.  $V_{GE}$   
 $T_J = 150^\circ\text{C}$



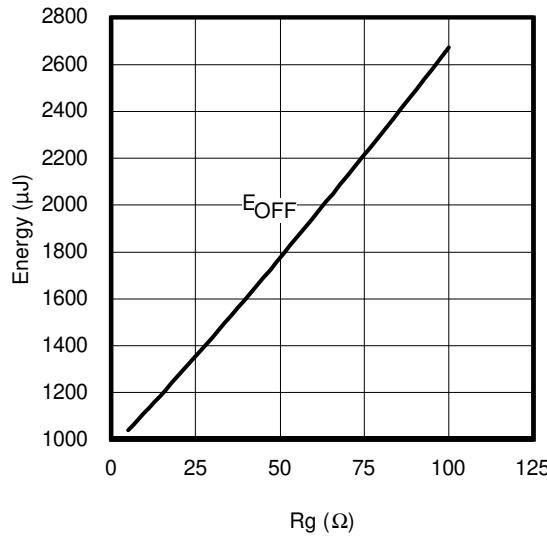
**Fig. 12** - Typ. Transfer Characteristics  
 $V_{CE} = 50\text{V}$ ;  $t_p = 30\mu\text{s}$



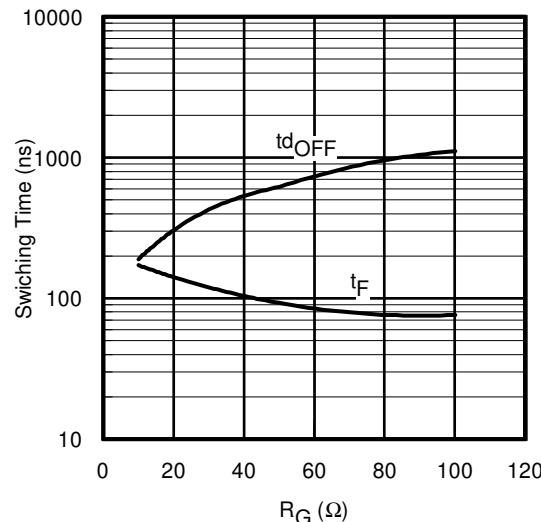
**Fig. 13 - Typ. Energy Loss vs.  $I_C$**   
 $T_J = 150^\circ\text{C}$ ;  $L = 680\mu\text{H}$ ;  $V_{CE} = 600\text{V}$ ,  $R_G = 10\Omega$ ;  $V_{GE} = 15\text{V}$



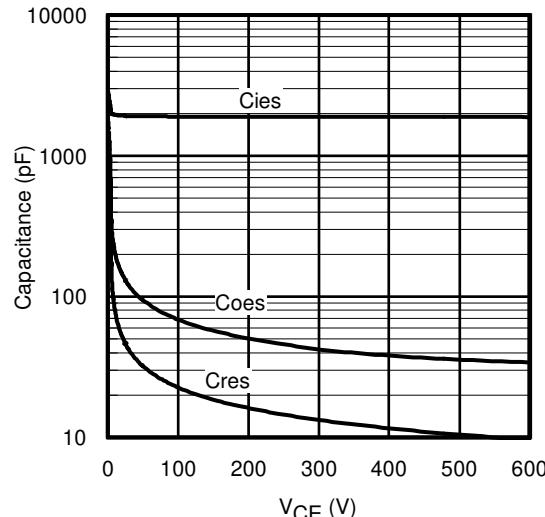
**Fig. 14 - Typ. Switching Time vs.  $I_C$**   
 $T_J = 150^\circ\text{C}$ ;  $L = 680\mu\text{H}$ ;  $V_{CE} = 600\text{V}$ ,  $R_G = 10\Omega$ ;  $V_{GE} = 15\text{V}$



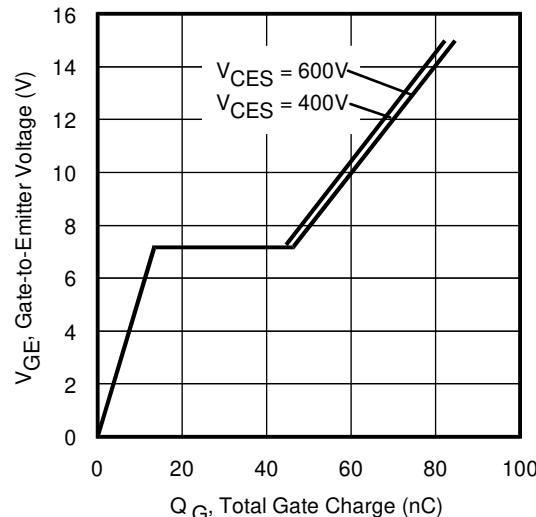
**Fig. 15 - Typ. Energy Loss vs.  $R_G$**   
 $T_J = 150^\circ\text{C}$ ;  $L = 680\mu\text{H}$ ;  $V_{CE} = 600\text{V}$ ,  $I_{CE} = 20\text{A}$ ;  $V_{GE} = 15\text{V}$



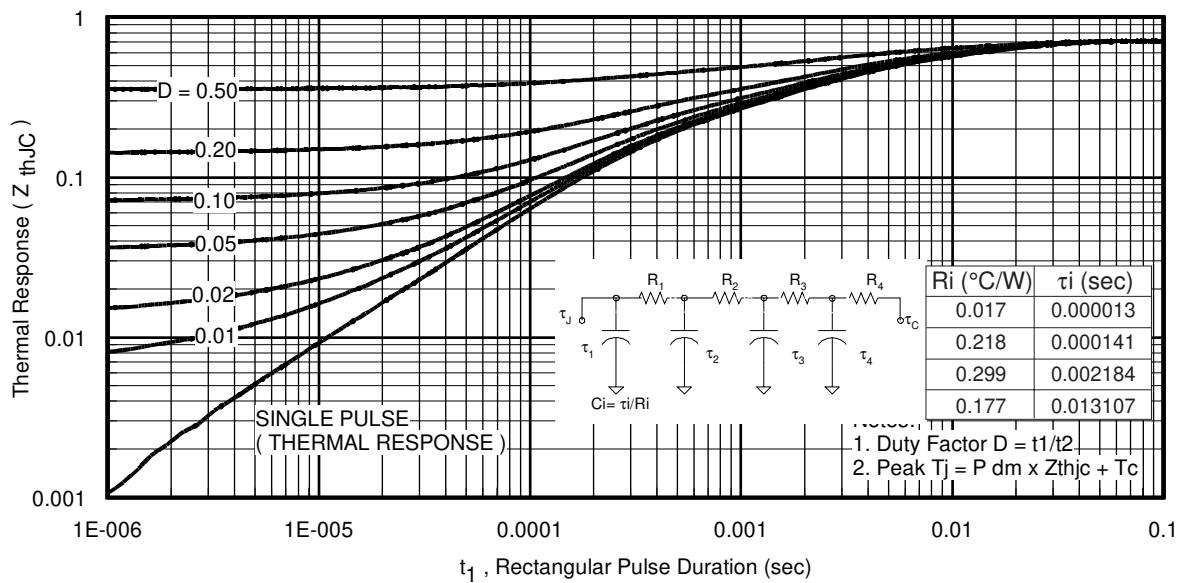
**Fig. 16 - Typ. Switching Time vs.  $R_G$**   
 $T_J = 150^\circ\text{C}$ ;  $L = 680\mu\text{H}$ ;  $V_{CE} = 600\text{V}$ ,  $I_{CE} = 20\text{A}$ ;  $V_{GE} = 15\text{V}$



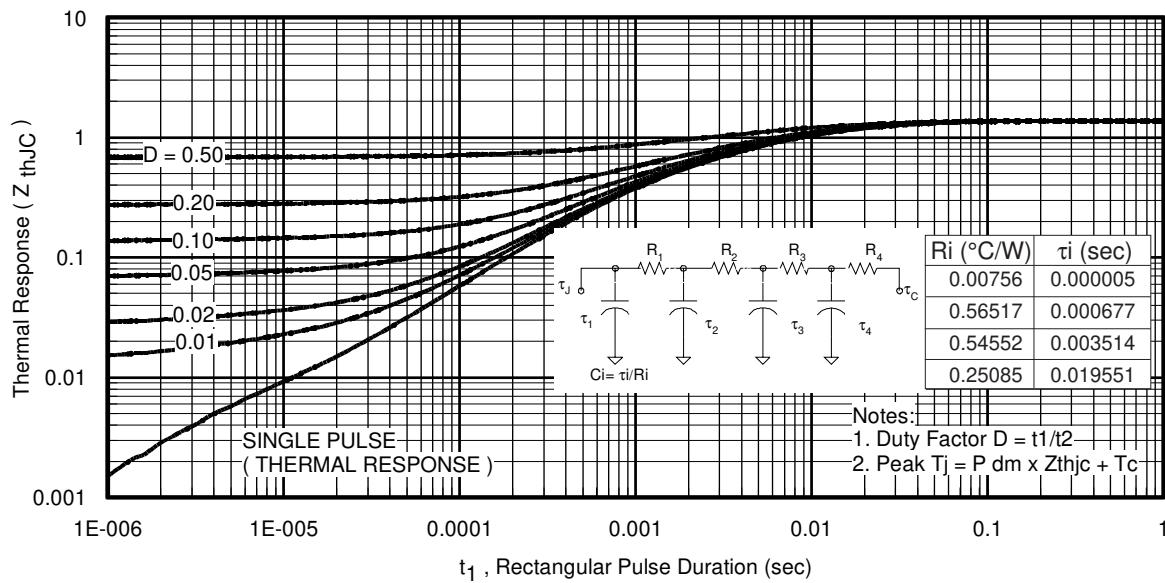
**Fig. 17 - Typ. Capacitance vs.  $V_{CE}$**   
 $V_{GE} = 0\text{V}$ ;  $f = 1\text{MHz}$



**Fig. 18 - Typical Gate Charge vs.  $V_{GE}$**   
 $I_{CE} = 20\text{A}$ ;  $L = 2.4\text{mH}$



**Fig 19.** Maximum Transient Thermal Impedance, Junction-to-Case (IGBT)



**Fig. 20.** Maximum Transient Thermal Impedance, Junction-to-Case (DIODE)

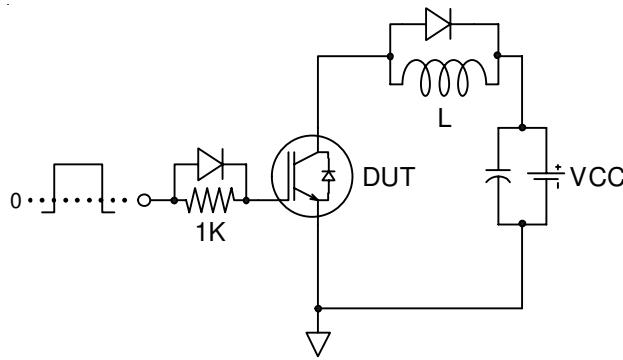


Fig.C.T.1 - Gate Charge Circuit (turn-off)

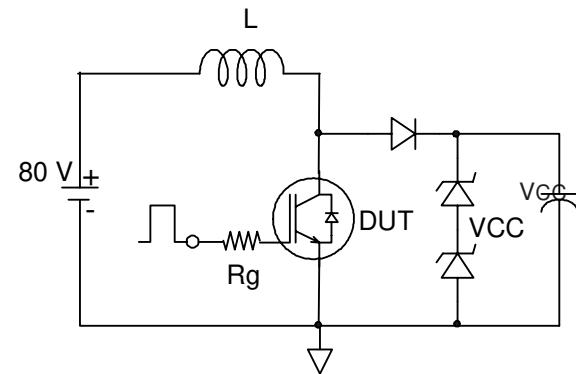


Fig.C.T.2 - RBSOA Circuit

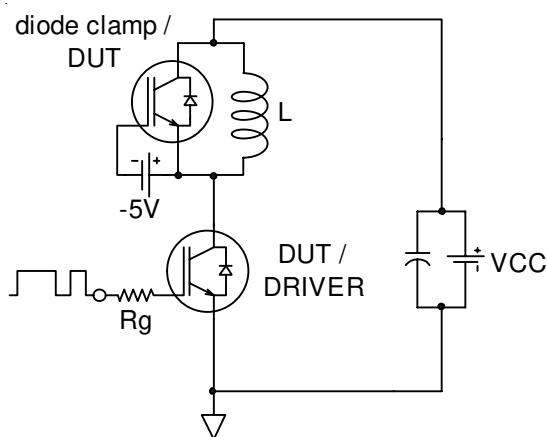


Fig.C.T.3 - Switching Loss Circuit

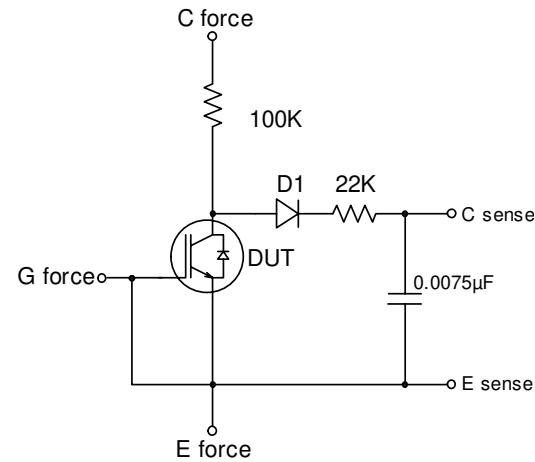
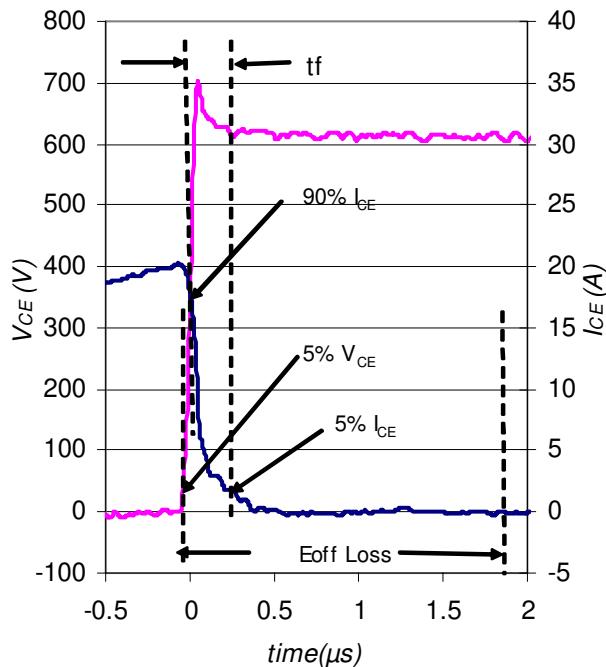
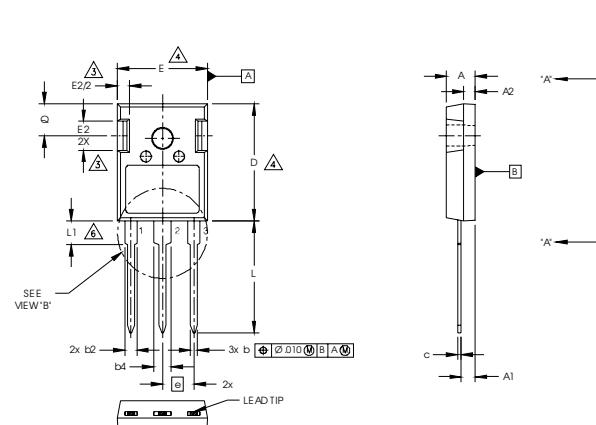


Fig.C.T.4 - BVCES Filter Circuit

Fig. WF1 - Typ. Turn-off Loss Waveform  
@ T<sub>J</sub> = 150°C using Fig. CT.3

## TO-247AD Package Outline

(Dimensions are shown in millimeters (inches))



SYMBOL	DIMENSIONS		NOTES
	INCHES	MILLIMETERS	
	MIN.	MAX.	
A	.190	.204	4.83 5.20
A1	.090	.100	2.29 2.54
A2	.075	.085	1.91 2.16
b	.042	.052	1.07 1.33
b2	.075	.094	1.91 2.41
b4	.113	.133	2.87 3.38
c	.022	.026	.55 0.68
D	.819	.830	20.80 21.10
D1	.640	.694	16.25 17.65
E	.620	.635	15.75 16.13
E1	.512	.570	13.00 14.50
E2	.145	.196	3.68 5.00
e	.215	Typical	5.45 Typical
L	.780	.800	19.80 20.32
L1	.161	.173	4.10 4.40
Ø P	.138	.143	3.51 3.65
Q	.216	.236	5.49 6.00
S	.238	.248	6.04 6.30

### LEAD ASSIGNMENTS

#### HEXFET

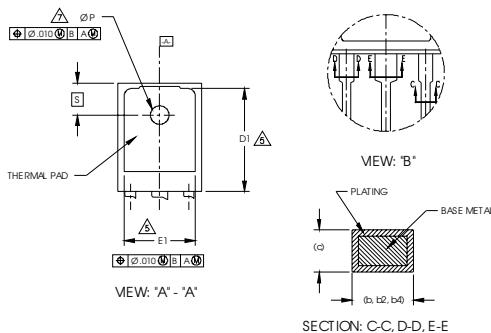
- 1.- GATE
- 2.- DRAIN
- 3.- SOURCE
- 4.- DRAIN

#### IGBTs, CoPACK

- 1.- GATE
- 2.- COLLECTOR
- 3.- Emitter
- 4.- COLLECTOR

#### DIODES

- 1.- ANODE/OPEN
- 2.- CATHODE
- 3.- ANODE



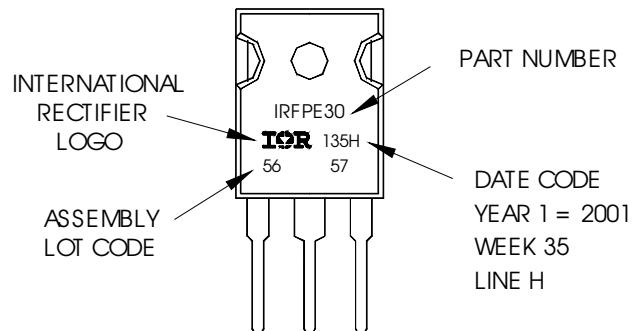
#### NOTES:

- 1 DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M 1994.
- 2 DIMENSIONS ARE SHOWN IN INCHES AND MILLIMETERS.
- 3 CONTOUR OF SLOT OPTIONAL.
- 4 DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- 5 THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS D1 & E1.
- 6 LEAD FINISH UNCONTROLLED IN L1.
- 7 Ø P TO HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM HOLE DIAMETER OF .154 INCH.

## TO-247AD Part Marking Information

EXAMPLE: THIS IS AN IRFPE30  
WITH ASSEMBLY  
LOT CODE 5657  
ASSEMBLED ON WW 35, 2001  
IN THE ASSEMBLY LINE "H"

Note: "P" in assembly line position  
indicates "Lead-Free"



TO-247AD package is not recommended for Surface Mount Application.

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

**Qualification information<sup>†</sup>**

Qualification level	Industrial <sup>††</sup> (per JEDEC JESD47F <sup>†††</sup> guidelines )	
Moisture Sensitivity Level	TO-247AD	N/A (per JEDEC J-S TD-020D <sup>†††</sup> )
RoHS compliant	Yes	

<sup>†</sup> Qualification standards can be found at International Rectifier's web site  
<http://www.irf.com/product-info/reliability>

<sup>††</sup> Higher qualification ratings may be available should the user have such requirements.  
Please contact your International Rectifier sales representative for further information:  
<http://www.irf.com/whoto-call/salesrep/>

<sup>†††</sup> Applicable version of JEDEC standard at the time of product release.

International  
**IR** Rectifier

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To contact International Rectifier, please visit <http://www.irf.com/whoto-call/>